

The Catholic University of America
Metropolitan School of Professional Studies
Sheehy Scholarship
2018-2019 Academic Year

Student Information

Name:

Street Address:

City:

State:

Zip:

Home Phone:

Work Phone:

E-Mail:

7-Digit Student ID:

Do you receive any tuition aid other than loans? (e.g. scholarships or employee benefits?) Yes No

If yes, please describe:

Cumulative CUA GPA:

Total Credits (including credits officially transferred to CUA):

Enrollment Information

Number of Credits Planned Per Semester for the 2018-2019 Academic Year (Please check all semesters you plan on enrolling and list your expected number of credits):

Summer 2018 _____ credits Fall 2018 _____ credits Spring 2019 _____ credits

Scholarship Application Requirements

- The Free Application for Federal Student Aid (FAFSA) must be submitted in order for this application to be considered. Please attach a PDF copy of your 2018/2019 FAFSA Student Aid Report (SAR) to your application email
- Along with this application, please submit a 450-500-word (i.e., 2 pages) statement describing: 1) how this scholarship will help you meet your educational and career goals, and 2) your financial need.
- Scholarship Application Deadline:** Student only need to apply once per academic year. The application deadlines below indicate deadlines for each semester. If you do not plan on attending in summer, the deadline is not until June 15th.
 - **Summer 2018 – April 15th**
 - **Fall 2018 – June 15th**
 - **Spring 2019 – December 15th**

Type your name below to agree to terms of this Scholarship

Acknowledged by:

Date:

Applications must be sent via CUA STUDENT ACCOUNT EMAIL ONLY to Tony Boehm at: Boehm@cua.edu. Please put SHEEHY SCHOLARSHIP APPLICATION and your name in the subject line. Please attach all three documents in one e-mail. Incomplete applications and/or separate emails will not be accepted. You will receive an email confirmation of your completed application within three business days. Contact Tony Boehm at Boehm@cua.edu if you have any questions regarding the application process.